

FSA4157, FSA4157A

Low-Voltage, 1Ω SPDT Analog Switch

Features

- FSA4157A Features Lower I_{CC} when the S Input is Lower Than V_{CC}
- Maximum 1.15Ω On Resistance (R_{ON}) at 4.5V V_{CC}
- 0.3Ω Maximum R_{ON} Flatness at 4.5V V_{CC}
- Space-Saving 6-lead, MicroPak™ and SC70 6 Packages
- Broad V_{CC} Operating Range:
 - FSA4157: 1.65V to 5.5V
 - FSA4157A: 2.7V to 5.5V
- Fast Turn-On and Turn-Off Time
- Break-Before-Make Enable Circuitry
- Over-Voltage Tolerant TTL-Compatible Control Circuitry

Description

FSA4157 and FSA4157A are high performance Single Pole/Double Throw (SPDT) analog switches. Both devices feature ultra low R_{ON} of 1.15Ω maximum at 4.5V V_{CC} and operates over the wide V_{CC} range of 1.65V to 5.5V for FSA4157, and 2.7V to 5.5V for FSA4157A. The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation. The select input is TTL level compatible.

The FSA4157A features very low quiescent current even when the control voltage is lower than the V_{CC} supply. This feature services the mobile handset applications very well allowing for the direct interface with baseband processor general purpose I/Os.

Technology Description

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVXL384 (FST3384) bus switch product.

Ordering Information

Part Number	Top Mark	Package Description	Packing Method
FSA4157P6X	A57	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3000 Units Tape and Reel
FSA4157L6X	EG	6-Lead MicroPak™, 1.0mm Wide	5000 Units Tape and Reel
FSA4157FHX	EG	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	5000 Units Tape and Reel
FSA4157AP6X	B57	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3000 Units Tape and Reel
FSA4157AL6X	EU	6-Lead MicroPak™, 1.0mm Wide	5000 Units Tape and Reel
FSA4157AFHX	EU	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	5000 Units Tape and Reel

Pin Configurations

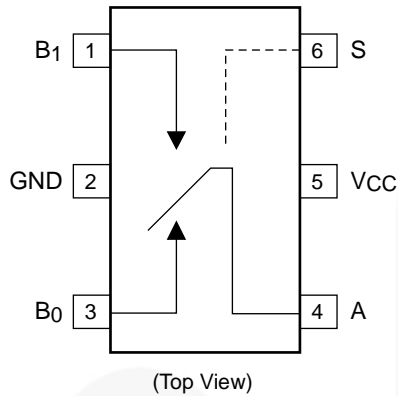


Figure 1. SC70 Pin Assignments

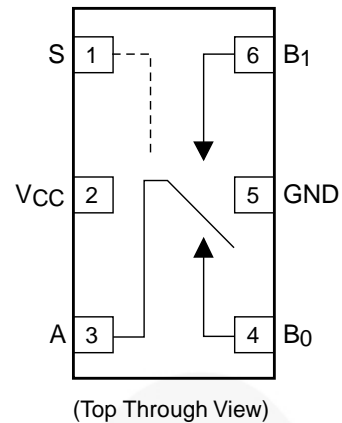


Figure 2. MicroPak™ Pin Assignments

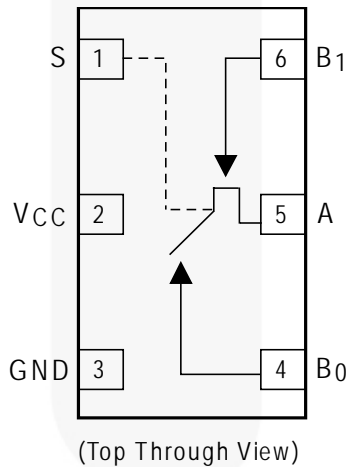


Figure 3. MicroPak2™ Pin Assignments

Pin Definitions

Pin# SC70	Pin# MicroPak™	Pin# MicroPak2™	Name	Description
1	6	6	B1	Data Ports
2	5	3	GND	Ground
3	4	4	B0	Data Ports
4	3	5	A	Data Ports
5	2	2	V _{CC}	Supply Voltage
6	1	1	S	Control Input

Truth Table

Control Input (S)	Function
Low	B0 connected to A
High	B1 connected to A

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V _{CC}	Supply Voltage		-0.5	6.0	V
V _S	DC Switch Voltage ⁽¹⁾		-0.5	V _{CC} + 0.5	V
V _{IN}	DC Input Voltage ⁽¹⁾		-0.5	6.0	V
I _{IK}	DC Input Diode Current		-50		mA
I _{SW}	Switch Current			200	mA
I _{SWPEAK}	Peak Switch Current (Pulse at 1ms duration, <10% Duty Cycle)			400	mA
P _D	Power Dissipation at 85°C	SC70		180	mW
		MicroPak™			
T _{STG}	Storage Temperature Range		-65	+150	°C
T _J	Maximum Junction Temperature			+150	°C
T _L	Lead Temperature (Soldering, 10 seconds)			+260	°C
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114 (FSA4157A)		7500	V

Note:

1. Input and output negative ratings may be exceeded if input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Min.	Max.	Unit
V _{CC}	Supply Voltage	FSA4157	1.65	5.50	V
		FSA4157A	2.7	5.5	
V _{CNTRL}	Control Input Voltage ⁽²⁾		0	V _{CC}	V
V _{SW}	Switch Input Voltage		0	V _{CC}	V
T _A	Operating Temperature		-40	+85	°C
θ _{JA}	Thermal Resistance in Still Air	SC70		350	°C/W
		MicroPak™ (Estimated)		330	

Note:

2. Control input must be held HIGH or LOW and it must not float.

DC Electrical Characteristics

Typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V _{CC} (V)	Ambient Temperature					Units
				-25°			-40 to +85°C		
				Min.	Typ.	Max.	Min.	Max.	
V _{IH}	Input Voltage High	FSA4157 Only	1.8 to 2.7				1.0		V
			2.7 to 3.6				2.0		
			4.5 to 5.5				2.4		
V _{IL}	Input Voltage Low	FSA4157 Only	1.8 to 2.7					0.4	V
		FSA4157A Only	2.7 to 3.6					0.4	
			2.7 to 3.6					0.6	
			4.5 to 5.5					0.8	
I _{IN}	Control Input Leakage	V _{IN} =0V to V _{CC}	2.7 to 3.6				-1.0	1.0	µA
			4.5 to 5.5				-1.0	1.0	
I _{NO(OFF)} , I _{NC(OFF)}	Off Leakage Current of Port B0 and B1	A=1V, 4.5v, B ₀ or B ₁ =4.5, 1V	5.5	-2		2	-20	20	nA
I _{A(ON)}	On Leakage Current of Port A	A=1V, 4.5v, B ₀ or B ₁ =4.5, 1V,4.5V or Floating	5.5	-4		4	-40	40	nA
R _{ON}	Switch On Resistance	I _{OUT} =100mA, B ₀ or B ₁ =1.5V	2.7		2.6	4.0		4.3	Ω
		I _{OUT} =100mA, B ₀ or B ₁ =3.5V	4.5		0.95	1.15		1.30	
ΔR _{ON}	On Resistance Matching Between Channels ⁽⁴⁾	I _{OUT} =100mA, B ₀ or B ₁ =1.5V	4.5		0.06	0.12		0.15	Ω
R _{FLAT(ON)}	On Resistance Flatness ⁽⁴⁾	I _{OUT} =100mA, B ₀ or B ₁ =0V, 0.75V, 1.5V	2.7		1.4				Ω
		I _{OUT} =100mA, B ₀ or B ₁ =0V, 1V, 2V	4.5		0.2	0.3		0.4	
I _{CC}	Quiescent Supply Current	V _{IN} =0V or V _{CC} , I _{OUT} =0V	3.6		0.1	0.5		1.0	µA
			5.5		0.1	0.5		1.0	
ΔI _{CC}	Increase in I _{CC} per Input	One Input at 2.7V, others at V _{CC} or GND (FSA4157A Only)	4.3		0.2			10.0	µA

Notes:

- Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (A or B ports).
- Δ R_{ON} = R_{ON max} – R_{ON min} measured at identical V_{CC}, temperature, and voltage.
- Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.

AC Electrical Characteristics

Typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V _{CC} (V)	Ambient Temperature					Units	Figure
				-25°			-40 to +85°C			
				Min.	Typ.	Max.	Min.	Max.		
t _{ON}	Turn-On Time	B ₀ or B ₁ =1.5V, R _L =50Ω, C _L =35pF (FSA4157A Only)	2.7 to 3.6			60		65	ns	Figure 9
		B ₀ or B ₁ =1.5V, R _L =50Ω, C _L =35pF	2.7 to 3.6			50		60		
		B ₀ or B ₁ =1.5V, R _L =50Ω, C _L =35pF	4.5 to 5.5			35		40		
t _{OFF}	Turn-Off Time	B ₀ or B ₁ =1.5V, R _L =50Ω, C _L =35pF	2.7 to 3.6			20		30	ns	Figure 9
		B ₀ or B ₁ =1.5V, R _L =50Ω, C _L =35pF	4.5 to 5.5			15		20		
t _{BBM}	Break-Before-Make Time	FSA4157	2.7 to 3.6						ns	Figure 10
			4.5 to 5.5		20					
		FSA4157A Only	4.5 to 5.5		25					
Q	Charge Injection	C _L =1.0nF, V _{GE} =0V, R _{GEN} =0Ω	2.7 to 3.6		10				pC	Figure 12
			4.5 to 5.5		20					
OIRR	Off Isolation	f=1MHz, R _L =50Ω	2.7 to 3.6		-70				dB	Figure 11
			4.5 to 5.5		-70					
Xtalk	Crosstalk	f=1MHz, R _L =50Ω	2.7 to 3.6		-70				dB	Figure 11
			4.5 to 5.5		-70					
BW	-3db Bandwidth	R _L =50Ω	2.7 to 3.6			300			MHz	Figure 14
			4.5 to 5.5			300				
THD	Total Harmon Distortion	R _L =600Ω, V _{IN} =0.5, f=20Hz to 20kHz	2.7 to 3.6		0.002				%	Figure 15
			4.5 to 5.5		0.002					

Capacitance

Symbol	Parameter	Conditions	V _{CC} (V)	Ambient Temperature -25°			Units	Figure
				Min.	Typ.	Max.		
C _{IN}	Control Pin Input Capacitance	f=1MHz	0		3.5		pF	Figure 13
C _{OFF}	B Port Off Capacitance	f=1MHz	4.5		12.0		pF	Figure 13
C _{ON}	On Capacitance	f=1MHz	4.5		40.0		pF	Figure 13

Typical Performance Characteristics

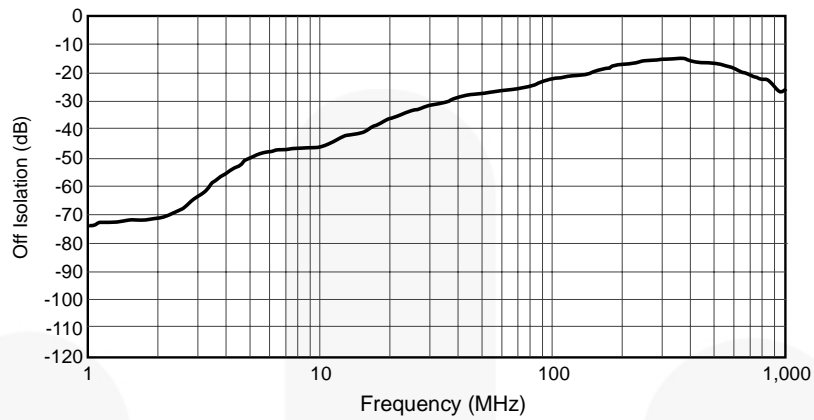


Figure 4. Off Isolation, $V_{CC} = 2.7V$ to $5.5V$

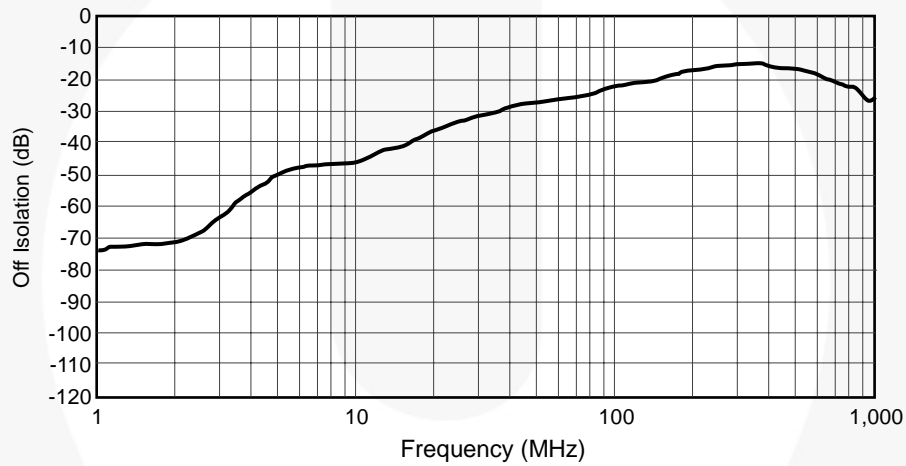


Figure 5. Crosstalk, $V_{CC} = 2.7V$ to $5.5V$

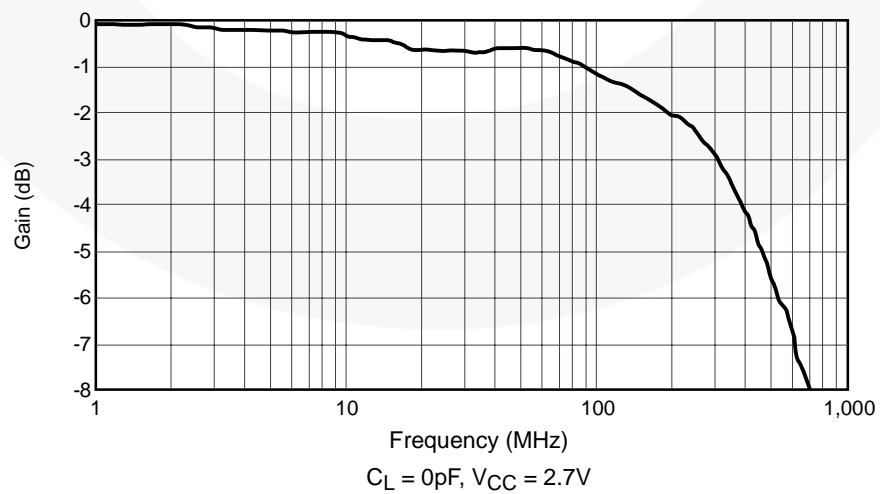


Figure 6. Bandwidth, $V_{CC} = 2.7V$ to $5.5V$

Typical Performance Characteristics (Continued)

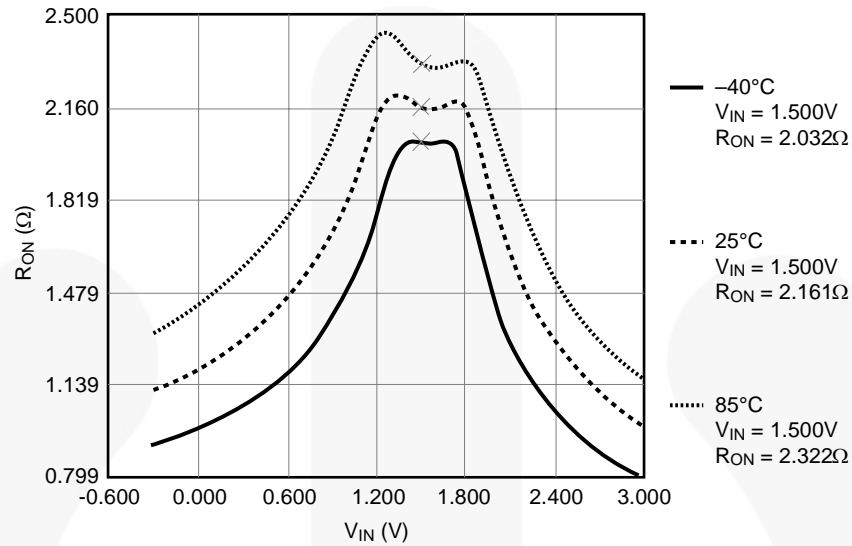


Figure 7. R_{ON} Switch On Resistance, $I_{ON} = 100\text{mA}$, $V_{CC} = 2.7$

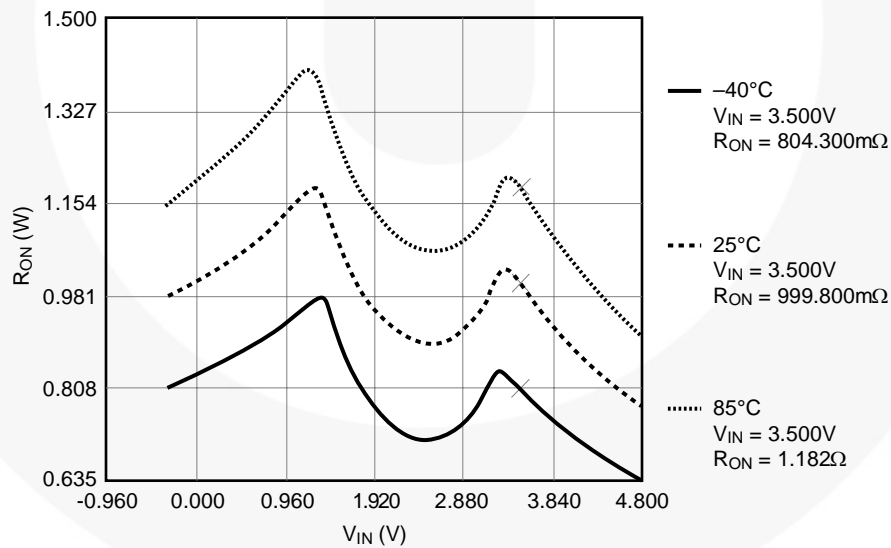


Figure 8. R_{ON} Switch On Resistance, $I_{ON} = 100\text{mA}$, $V_{CC} = 4.5\text{V}$

AC Loadings and Waveforms

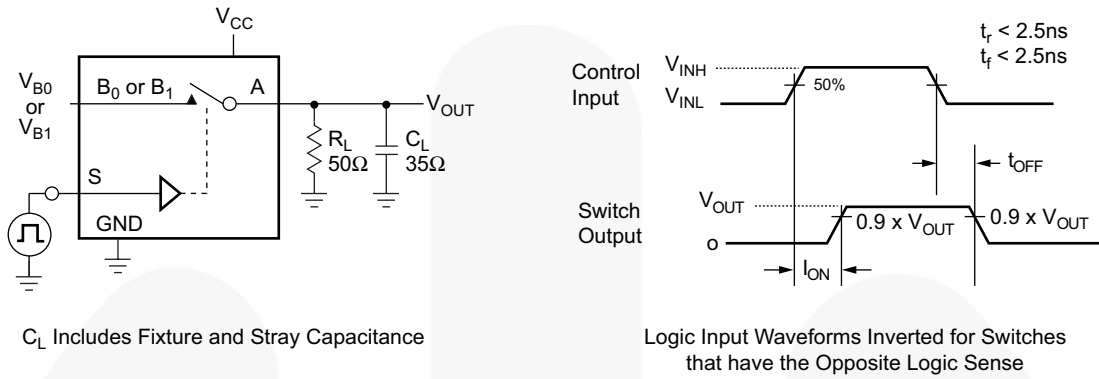


Figure 9. Turn On / Off Timing

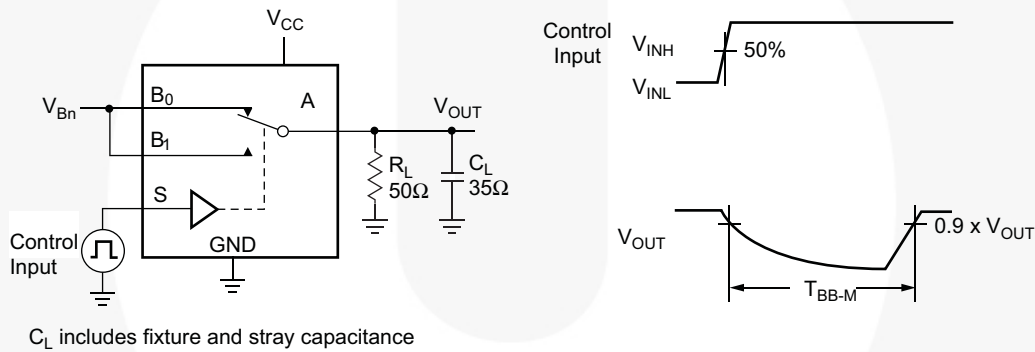


Figure 10. Break Before Make Timing

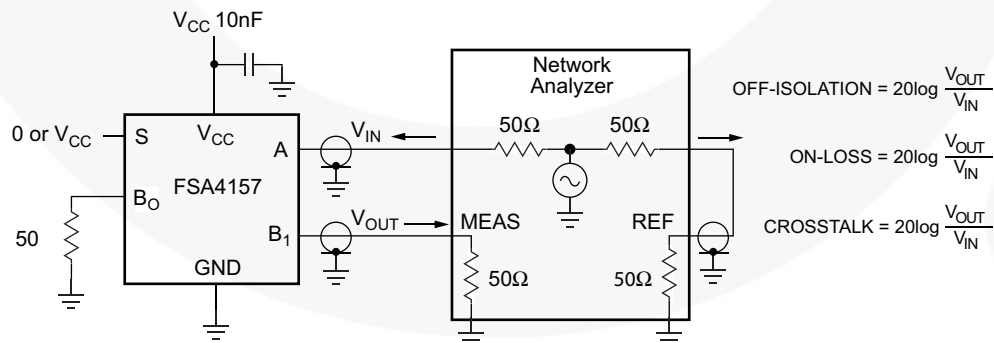


Figure 11. Off Isolation and Crosstalk

AC Loadings and Waveforms (Continued)

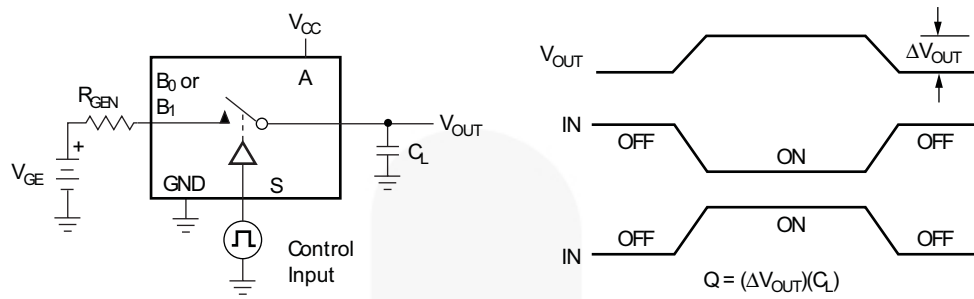


Figure 12. Charge Injection

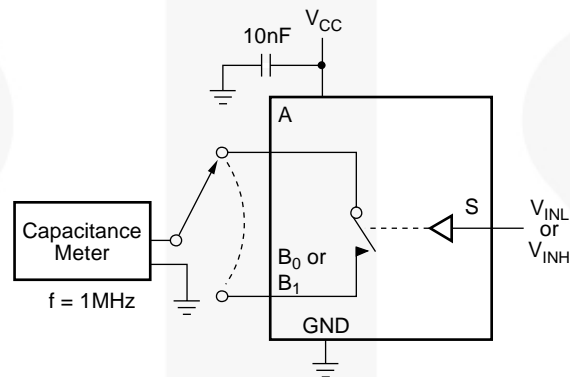


Figure 13. On / Off Capacitance Measurement Setup

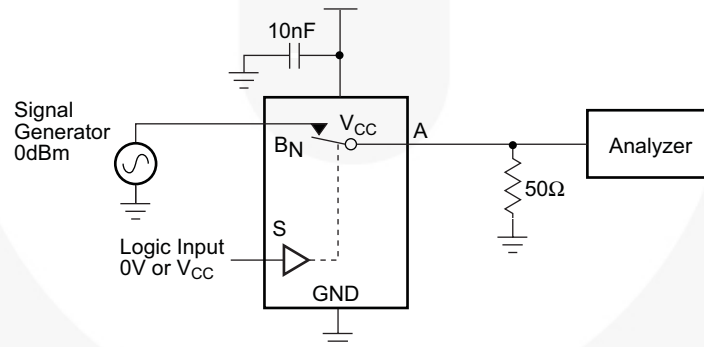


Figure 14. Bandwidth

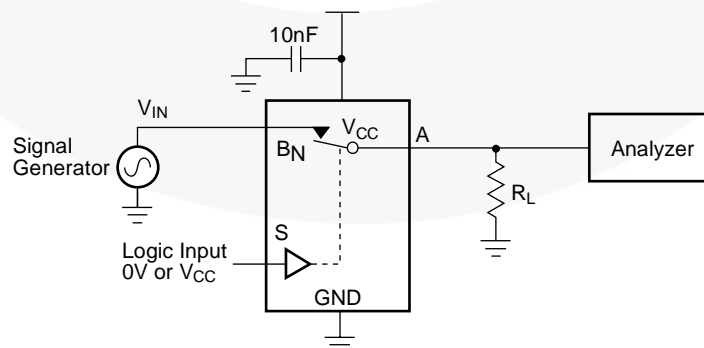


Figure 15. Harmonic Distortion

Physical Dimensions

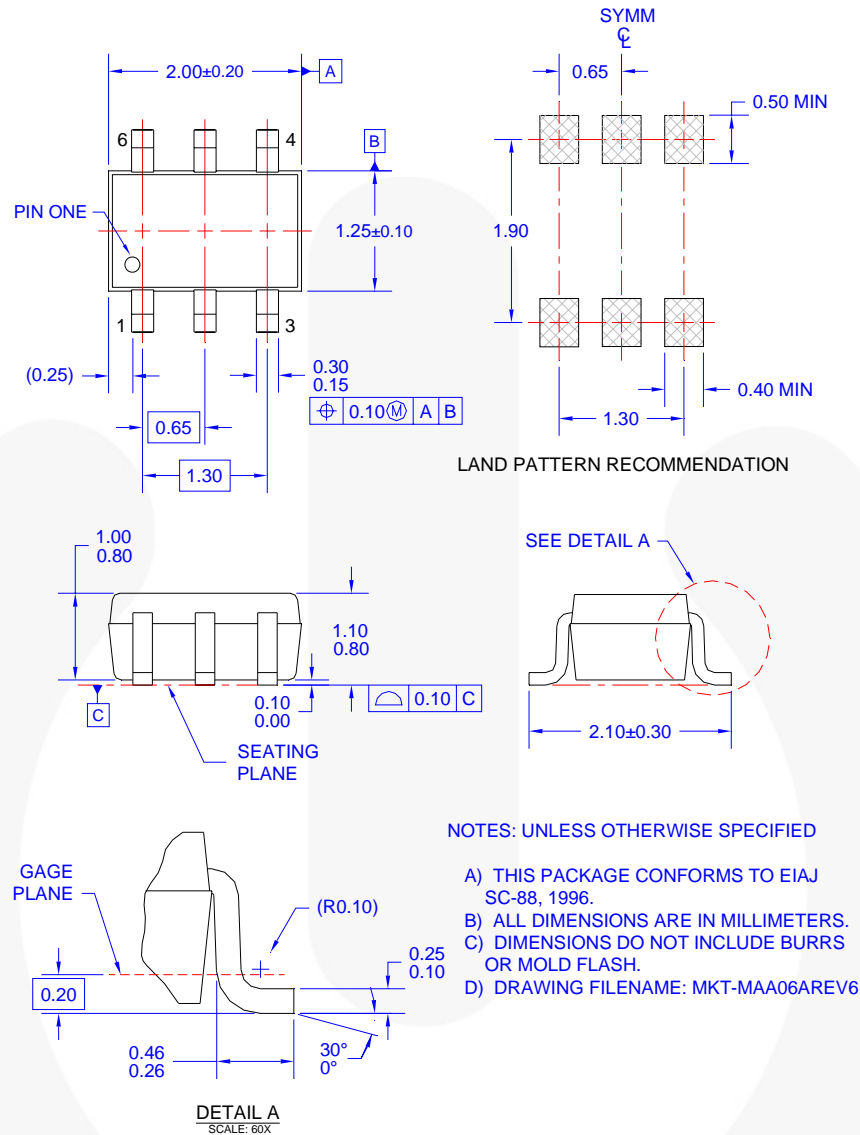


Figure 16. 6-Lead, SC70, EIAJ SC88 1.25mm Wide Package

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Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/analog/pdf/sc70-6_tr.pdf

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
P6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions (Continued)

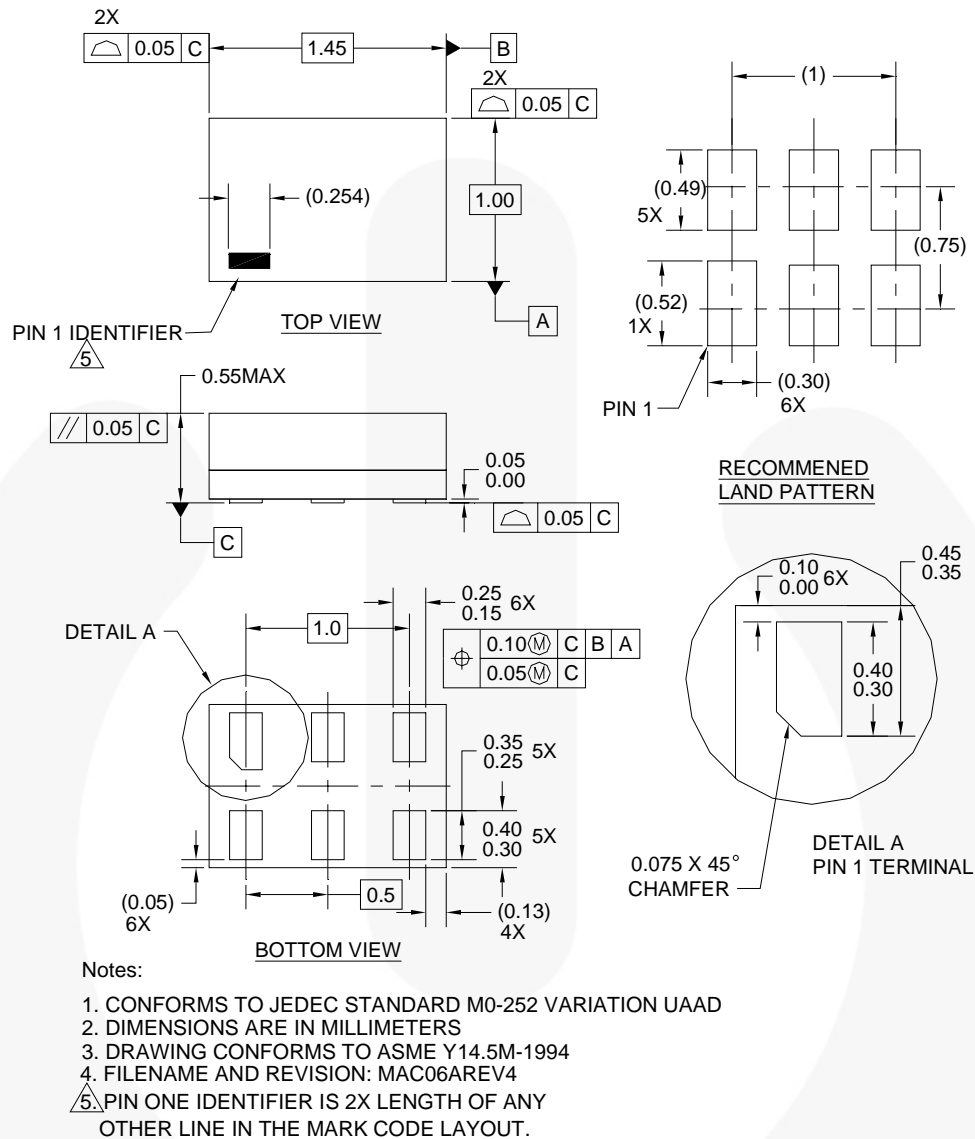


Figure 17. 6-Lead, Micropak™ 1.0mm Wide Package

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Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
L6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions (Continued)

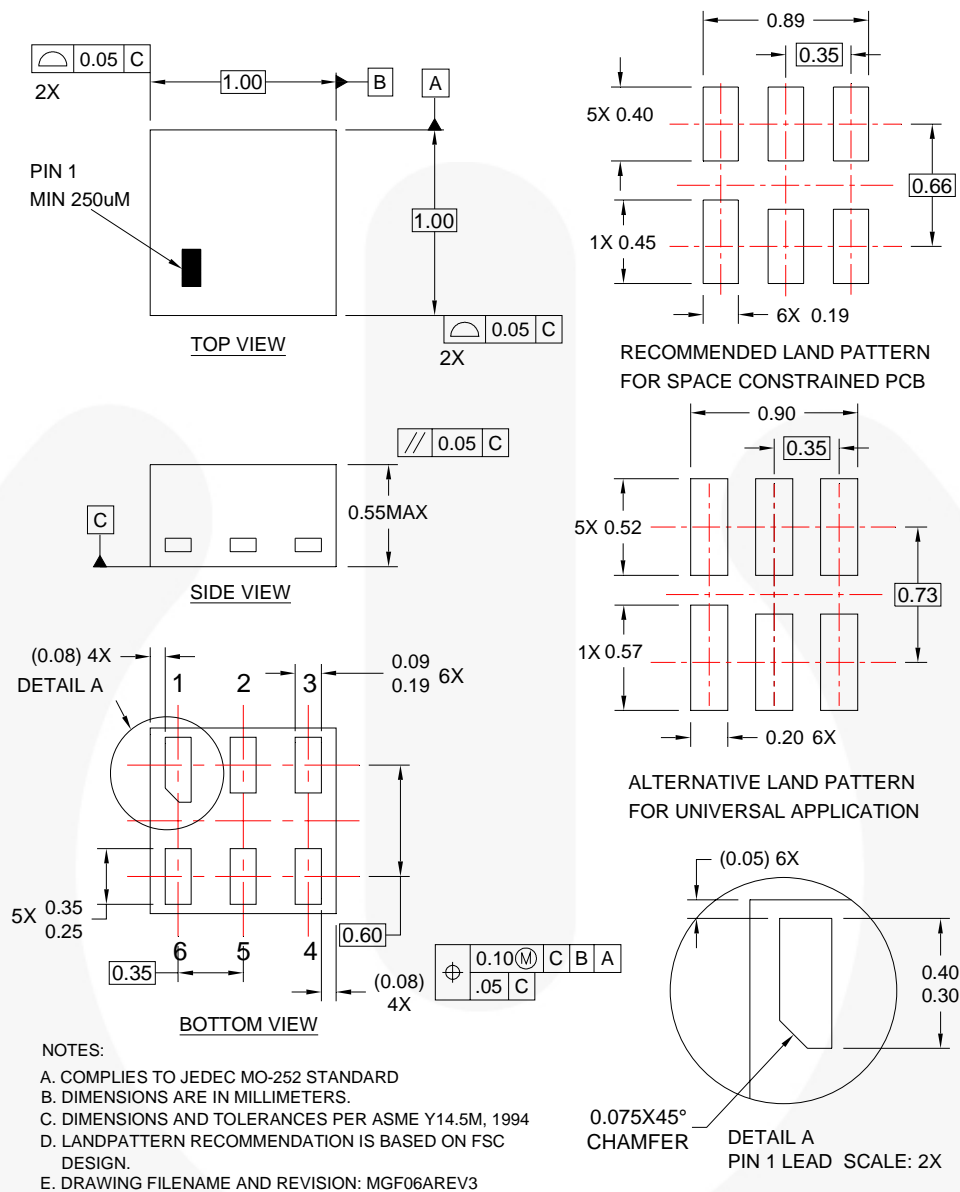


Figure 18. 6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch

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Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/packaging/MicroPAK2_6L_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
FHX	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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